

X-CON BRAND

CONDUCTIVE POLYMER ALUMINUM SOLID CAPACITORS

PRODUCT SPECIFICATION 規格書

CUSTOMER :

(客戶): 志盛翔

DATE :

(日期): 2020-8-18

CATEGORY (品名)	:	CONDUCTIVE POLYMER ALUMINUM SOLID CAPACITORS
DESCRIPTION (型号)	•	ULR 16V330μF (φ6.3x11)
VERSION (版本)	:	01
Customer P/N	•	/
SUPPLIER	:	/

SUPPLI	ER	CUST	OMER
PREPARED (拟定)	CHECKED (审核)	APPROVAL (批准)	SIGNATURE (签名)
孟庆庆	付婷婷		

X-CON Electronics Limited

SOLID POLYMER CAPACITOR SPECIFICATION ULR SERIES

	SPECIFICATION ULR SERIES					ALTERNATION HISTORY RECORDS		
Rev.	Date	Mark	Page	Contents	Purpose	Drafter	Approve	

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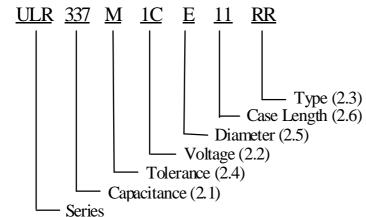
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1. Application

This specification applies to conductive polymer aluminum solid capacitors used in electronic equipment.

2. Part Number System



2.1 <u>Capacitance code</u>

Code	337
Capacitance (µF)	330

2.2 Rated voltage code

Code	1C
Voltage (W.V.)	16

2.3 <u>Type</u>

Ξ.		
	Code	RR
	Туре	Bulk

- 2.4 <u>Capacitance tolerance</u> "M" stands for -20% ~ +20%
- 2.5 <u>Diameter</u>

Code	Е
Diameter	6.3

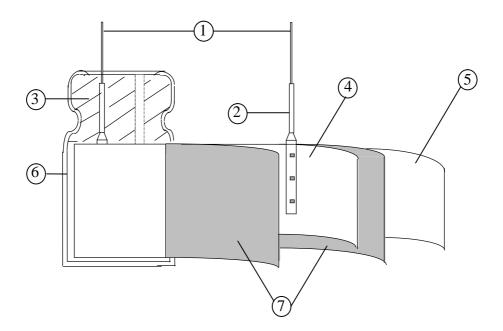
2.6 <u>Case length</u> 11=11mm,

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3.Construction

Single ended type to be produced to fix the terminals to anode and cathode foil, and wind together with paper, and then wound element to be formed and carbonized, impregnated with polymer and polymerized, then will be enclosed in an aluminum case. Finally sealed up tightly with end seal rubber.



No	Component	Material
		Tinned Copper Line
1	Lead Line	or CP Line(Pb Free)
2	Terminal	Aluminum
3	Sealing Material	Rubber
4	Al-Foil (+)	Aluminum
5	Al-Foil (-)	Aluminum
6	Case	Aluminum
7	Electrolyte paper	Manila Hemp

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4. Characteristics

Standard atmospheric conditions

Unless otherwise specified, the standard range of atmospheric conditions for making measurements and tests is as follows:

Ambient temperature:15°C to 35°CRelative humidity:45% to75%Air Pressure:86kPa to 106kPa

If there is any doubt about the results, measurement shall be made within the following conditions: Ambient temperature: $20^{\circ}C \pm 2^{\circ}C$ Relative humidity : 60% to 70%Air Pressure : 86kPa to 106kPa

Operating temperature range

The ambient temperature range at which the capacitor can be operated continuously at rated voltage is -55°C to 105°C.

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	ITEM		I	ERFORMANCE			
4.1	Rated voltage (WV) Surge voltage (SV)	WV (V.DC) SV (V.DC)	16 18.4				
4.2	Nominal capacitance (Tolerance)	<condition> Measuring Frequence Measuring Voltage Measuring Tempera <criteria> Shall be within the s</criteria></condition>	: No ture : 20±	more than 0.5Vrms 2℃			
4.3	Leakage current	$\Omega\pm10\Omega$) so that te when measured after In case leakage curr	rminal volt 2 minutes ent value e	capacitors through the series protective resistor (1k age may reach the rated voltage .The leakage current shall not exceed the values of the following equation. xceed the value shown in Table 3, remeasure after e rated voltage shown in 4.1 for 120minutes at 105° C			
4.4	tan δ	< Condition> See 4.2, for measurin < Criteria> Working voltage (tan δ (max.)	v)	ry, voltage and temperature.			
4.5	ESR	<condition>Measuring frequency : 100kHz to 300kHz; Measuring temperature:$20\pm2^{\circ}C$ Measuring point : 1mm max from the surface of a sealing resin on the lead wire.<criteria> (20°C)Less than the initial limit(See Table 3).</criteria></condition>					

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		<condition< th=""><th>Temperature(°C)</th><th>Item</th><th>Characteristics</th></condition<>	Temperature(°C)	Item	Characteristics	
Tempe		1	20±2	Measure: Capacitance、 tanδ 、 Impedance		
		2	-55+3	Z-55°C / 20°C	≤1.25	
	Temperature	3	Keep at 15 to 35°C for 15 minutes or more			
.6	characteristic	4	105 ± 2	$Z105^\circ\!\!\mathrm{C} \ / \ 20^\circ\!\!\mathrm{C}$	≤1.25	
				∆ C/C 20° C	Within $\pm 5\%$ of step1	
		5	20±2	tanð	Less than or equal to the value of item 4.4	
		The C	dition> apacitor is stored at a ter e for 2000 +48/0 hours.			
		Item		formance		
				hin $\pm 20\%$ of initial c	apacitance	
		tan o	Les	Less than or equal to 1.5 times of the value of item 4.4		
	Load	ESR		Less than or equal to 1.5 times of the value of item 4.5		
4.7 life		Leak	age current Les	ess than or equal to the value of item 4.3		
• /	test	Appe	earance Not	able changes shall not	be found.	
. /						

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			l be 15~35℃.
	Surge	Item	Performance
4.8	test	Capacitance Change	Within $\pm 20\%$ of initial capacitance
		$\tan \delta$	Less than or equal to 1.5 times of the value of item 4.4
		ESR	Less than or equal to 1.5 times of the value of item 4.5
		Leakage current	Less than or equal to the value of item 4.3
		$60\pm2^{\circ}$ C, the character	oltage is always applied. xposed for 1000±48 hours in an atmosphere of 90~95%RH at istic change shall meet the following requirement.
		<criteria> Item</criteria>	Performance
		Capacitance Change	Within ±20% of initial capacitance
	_	$\tan \delta$	Less than or equal to 1.5 times of the value of item 4.4
4.9	Damp heat test	ESR	Less than or equal to 1.5 times of the value of item 4.5
	test	Leakage current	Less than or equal to the value of item 4.3
		Appearance	Notable changes shall not be found.

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4.10	Maximum permissible (ripple current)	At 100kHz aı Table 3	nd can b d value and sha ultiplier	e applied at point of D.C voltage	maximum oper ge and the peak	naximum A.C cu rating temperatur c A.C voltage sha 10kHz≤ f<100kHz 0.70	re see all not	exceed the DkHz≤ 500kHz 1.00
	Rapid change	Applied voltag Cycle number: Test diagram: Performance:	5 cycle Fig.1	S	meet the follow	Roo $30\pm 3 \min$ n or less	5±2℃ m temp ±±3℃ n after	
4.11	of temperature	Capacitance	change	Within $\pm 10\%$ of initial capacitance				
		tan δ			or equal to valu			
		Leakage cu	rrent	Less than over the contract of	-	value of item 4.3	3 (after	
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		a) Lead pull strength					
			-	· •	erminal in the axial d	lirection a	nd acting
		in a direction away from the body for 10 ± 1 s.					
		Lead	wire diameter	: (mm)	Load force ((N)	
		0.5	< d ≤0.8		10		
		b) Lead bending					
					position and the weig		
					the capacitor is slow		
4.12	Lead strength		on and then r	eturned to a	vertical position thus	completi	ng bends
	_	for 2~3seconds.	1	1 • 4	·, 1· ,·		
					osite direction		
			re diameter (mm)	Load force (N))	
			d ≤0.8		5		
			ne characteris		t the following value	after a) o	or b) test.
		Item		Performance			
		Leakage curren			or equal to the value of		3
		Outward Appea	arance	No cutting	and slack of lead ter	minals	
4.13	Resistance to vibration	Frequency: 10 to 55 Amplitude: 0.75mm(Direction :X、Y、 Duration: 2hours/ ax The capacitors are su	Total excursi Z (3 axes) ial (Total 6 h apported as th	ion 1.5mm) ours)			
			1 1	Fig2			
		Derferrung	1 1	Fig2	denatio -1		Lo in M. I
		Performance: Capaci	I I I itance value s	Fig2 hall not show	-	-	
		capacitance when the	I I itance value s e value is mea	Fig2 hall not show asured within	30 minutes. Prior to	the comp	oletion of
		-	I I itance value s e value is mea	Fig2 hall not show asured within	30 minutes. Prior to	the comp	oletion of
		capacitance when the exam, Capacitance d	I I itance value s e value is mea	Fig2 hall not show asured within	30 minutes. Prior to	the comp	oletion of
		capacitance when the exam, Capacitance d exam.	I I itance value s e value is mea ifference sha	Fig2 hall not show asured within ll be within =	30 minutes. Prior to ±5% compared to the	the comp	oletion of
Issu	ed-date: 2018-1	capacitance when the exam, Capacitance d exam.	I I itance value s e value is mea ifference sha	Fig2 hall not show asured within	30 minutes. Prior to ±5% compared to the	the comp e initial v	oletion of alue the
Issu	ed-date: 2018-1 Version	capacitance when the exam, Capacitance d exam.	I I itance value s e value is mea ifference sha	Fig2 hall not show asured within ll be within =	30 minutes. Prior to ±5% compared to the	the comp	oletion of

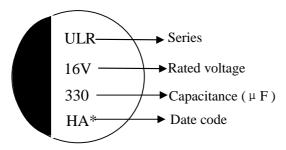
r		
4.14	Solderability	The capacitor shall be tested under the following conditions:Solder: Sn-3Ag-0.5CuSoldering temperature:245±3°CImmersing time: 3±0.5sImmersing depth: 1.5~ 2.0mm from the root.Flux: Approx .25% rosinPerformance:At least 95% of the dipped portion of the terminal shall be covered with new solder.
4.15	Resistance to soldering heat	A) Solder bath method Lead terminals of a capacitor are placed on the heat isolation board with thickness of 1.6±0.5mm. It will dip into the flux of isopropylaehol solution of colophony. Then it will be immersed at the surface of the solder with the following condition: Solder : Sn-3Ag-0.5Cu Soldering temperature : $260 \pm 5^{\circ}$ C Immersing time : $10\pm1s$ Heat protector: t=1.6mm glass -epoxy board B) Soldering iron method Bit temperature : $400 \pm 10^{\circ}$ C Application time : $3\pm1/-0 s$ Heat protector: t=1.6mm glass -epoxy board For both methods, after the capacitor at thermal stability, the following items shall be measured: <u>Item Performance</u> Capacitance Change Within $\pm 5\%$ of initial capacitance tan δ Less than or equal to the value of item 4.4 <u>ESR</u> Less than or equal to the value of item 4.3 (after voltage treatment) Appearance Notable changes shall not be found.

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5. Product Marking

Marking Sample:



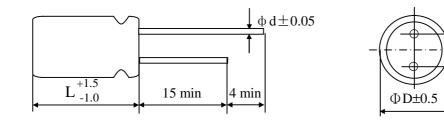
Year	2015			Н				present			
	2015	2016	2017	2018				ured we			2
Table 2						– Manu	facture	d year:	see Tab	le 1	
Week	1	2	3	4	5	6	7	8	9	10	11
Code	A	В	С	D	E	F	G	Н	Ι	J	K
Week	12	13	14	15	16	17	18	19	20	21	22
Code	L	М	Ν	0	Р	Q	R	S	Т	U	V
Week	23	24	25	26	27	28	29	30	31	32	33
Code	W	Х	Y	Ζ	A	B	<u>C</u>	D	E	F	G
Week	34	35	36	37	38	39	40	41	42	43	44
Code	H	Ī	<u>J</u>	K	L	M	<u>N</u>	<u>0</u>	<u>P</u>	Q	<u>R</u>
Week	45	46	47	48	49	50	51	52			
Code	<u>S</u>	<u>T</u>	U	V	W	X	<u>Y</u>	Z			

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F±0.5

6. Product Dimensions, Impedance & Maximum Permissible Ripple Current Unit: mm



φD	6.3
L	11
F	2.5
φd	0.6

Table 3

Working Voltage (V)	Capacitance (µF)	Dimension (D×L, mm)	Maximum permissible ripple current at 105°C 100kHz (mA rms)	ESR at 20°C 100kHz to300kHz (m Ω)	Leakage current (µA) 2min
16	330	6.3X11	3200	18	1056

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7.Application Guideline:

X-CON Solid Aluminum Electrolytic Capacitor should be used compliance with the following guidelines

7-1Circuit design

Prohibited Circuits for use

Do not use the capacitors with the following circuits.

- 1) Time constant circuits
- 2) Coupling circuits
- 3) Circuits which are greatly affected by leakage current
- 4) High impedance voltage retention circuits.
- 7-2. Voltage

1) Over voltage

The application of over-voltage and reverse voltage below can cause increases in leakage current and short circuits. Applied voltage, refers to the voltage value including the peak value of the transitional instantaneous voltage and the peak Value of ripple voltage, not just steady line voltage. Design your circuit so that the peak voltage does not exceed the stipulated voltage.

Over voltage exceeding the rated voltage may not be applied even for an instant as it may cause a short circuit.

2) Applied voltage

① Sum of the DC voltage value and the ripple voltage peak values must not exceed the rated voltage.

② When DC voltage is low, negative ripple voltage peak value must not become a reverse voltage that exceeds 10% of The rated voltage.

③ Use the X-CON within 20% of the rated voltage for applications which may cause the reverse voltage during the Transient phenomena when the power is tunid off or the source is switched.

7-3 Sudden charge and discharge restricted

Sudden charge and discharge may result in short circuit's large leakage current. Therefore, a protection circuits are recommended to design in when on of the following condition is expected.

1) The rush current exceeds 10A

2) The rush current exceeds 10 times of allowable ripple current of X-CON.

A protection resistor $(1K \Omega)$ must be inserted to the circuit during the charge and discharge when measuring the leakage Current.

7-4 Ripple current

Use the capacitors within the stipulated permitted ripple current. When excessive ripple current is applied to the capacitor, It causes increases in leakage current and short circuits due to self- heating. Even when using the capacitor under the Permissible ripple current, reverse voltage may occur if the DC bias voltage is low.

7-5 Leakage current

There is a risk of leakage current characteristics increasing even if the following use environments are within the stipulated range However, even if leakage current increases once, it has the characteristic that leakage current becomes small in most cases after voltage is applied due to its self-correction mechanism.

7-6 Failure rate

The main failure mode of X-CON is open mode primarily caused by electrostatic capacity drop at high temperature (i.e.wear out failure), besides random short circuit mode failures primarily caused by over voltage occurs as minor one. The time it takes to reach the failures mode can be extended by using the X-CON with reduced ambient temperature, ripple current and applied voltage.

7-7 Capacitor insulation

1) Insulation in the marking sleeve is not guaranteed. Be aware that the space between the case and the negative electrode Terminal is not insulated and has some resistance.

2) Be sure to completely separate the case, negative lead terminal, and positive lead terminal and PCB patterns with each other.

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7-8 Precautions for using capacitors

X-CON capacitors should not be used in the following environments.

1) Environments where the capacitor is subject to direct contact with salt water or oil can directly fall on it.

2) Environments where capacitors are exposed to direct sunlight.

3) High temperature (Avoid locating heat generating components around the X-CON and on the underside of the

PCB), or humid environments where condensation can form on the surface of the capacitor.

4) Environments where the capacitor is in contact with chemically active gases.

5) Acid or alkaline environments.

6) Environment subject to high-frequency induction.

7) Environment subject to excessive vibration and shock.

8.Long Term Storage

Store the X-CONs in sealed package bags after delivery per the table below;

X-CON Type	Before unsealing
Dedial lead type peaked in here	Must be used within 24~36 months after
Radial lead type packed in bags	delivery(unsealed status)
Dediel lead time neeked in tening method	Must be used within 24~36 months after
Radial lead type packed in taping method	delivery(unsealed status)

Before mounting and rated voltage voltage shouldn't be available 5) Precautions on the pitch between lead terminal and PCB The products can be used only when said pitch is match terminal and body of X-CON capacitors enduring in mounting 6) Precautions on the stress that lead terminal and body of X-CON capacitors enduring in mounting The products can be used for production only when lead terminal and body of X-CON capacitors enduring in mounting 1) Soldering with a soldering iron Both temperature and duration in mounting should meet the requirements of out-going SPEC; no stress should I allowed to occur in mounting; Don't let the tip of the soldering iron touch the X-CON itself. 2) Flow soldering X-CON capacitor body should be prohibited to submer in melted solder; both temperature and duration in mounting should meet the requirements of out-going SPEC; The rosin is not allowed to adhere to any where other than lead terminal. 1) Precautions on mounting status Do not till, bend twists X-CON; Do not allow other mat touch X-CON. 2) Washing the PCB (available cleaning agent 1)high quality alcohol-based cleaning fluid such as st-100s, 750L,750M;2) Detergents including substitute freon such as AK-225AES and IPA) Used immersion or ultrasonic waves to clean for a total less than 5 minutes and the temperature be less than 60 The conductivity, PH, specific gravity and water cleanin X-CON products should be dried with hot air (less that the maximum operating temperature).	0 Mounting Procoutions								
1) Used X-CON capacitors Not reused 2) LC-increased X-CON capacitors after long storage Apply them with rated voltage in series with 1K Ω resistance for 1 hour at the range between 60 and 70°C 3) X-CON capacitors dropped to the floor Not reused 4) Precautions on polar, capacitance and rated voltage Products without remarkable polar, capacitance and rat voltage shouldn't be available 5) Precautions on the pitch between lead terminal and PCB The products can be used only when said pitch is match terminal and body of X-CON capacitors enduring in mounting 1) Soldering with a soldering iron Both temperature and duration in mounting should meet the requirements of out-going SPEC; no stress should 1 allowed to occur in mounting; Don't let the tip of the soldering iron touch the X-CON itself. Mounting 2) Flow soldering X-CON capacitor body should be prohibited to submeet in melted solder; both temperature and duration in mounting should meet the requirements of out-going SPEC; The rosi is not allowed to adhere to any where other than lead terminal. 1) Precautions on mounting status Do not tilt, bend twists X-CON; Do not allow other mat touch X-CON. 2) Washing the PCB (available cleaning agent 1) high quality alcohol-based cleaning fluid such as st-100s. 750L,750M;2) Detergents including substitute freon such as AK-225AES an IPA) Used immersion or ultrasonic waves to clean for a total the maximum			a hafana maa	untina	Dispessi				
2) LC-increased X-CON capacitors Apply them with rated voltage in series with 1K Ω after long storage resistance for 1 hour at the range between 60 and 70°C 3) X-CON capacitors dropped to the floor Not reused 4) Precautions on polar, capacitance Products without remarkable polar, capacitance and rat voltage shouldn't be available 5) Precautions on the pitch between lead terminal and PCB The products can be used only when said pitch is match terminal and body of X-CON capacitors enduring in mounting 1) Soldering with a soldering iron Both temperature and duration in mounting should meet the requirements of out-going SPEC; no stress should I allowed to occur in mounting; Don't let the tip of the soldering iron touch the X-CON itself. Mounting 2) Flow soldering X-CON capacitor body should be prohibited to submere in melted solder; both temperature and duration in mounting; SPEC; The rosin is not allowed to adhere to any where other than lead terminal. After mounting 1) Precautions on mounting status Do not tilt, bend twists X-CON; Do not allow other mat touch X-CON. 2) Washing the PCB (available cleaning fluid such as st-100s, 750L,750M;2) Detergents including substitute freon such as AK-225AES and IPA) Used immersion or ultrasonic waves to clean for a total the maximum operating temperature).	Mounting phase				-				
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Before mounting 3) X-CON capacitors dropped to the floor Not reused 4) Precautions on polar, capacitance and rated voltage Products without remarkable polar, capacitance and rated voltage 5) Precautions on the pitch between lead terminal and PCB The products can be used only when said pitch is match terminal and body of X-CON capacitors enduring in mounting 6) Precautions on the stress that lead terminal and body of X-CON capacitors enduring in mounting The products can be used for production only when leat terminal and body of X-CON capacitors enduring in mounting 1) Soldering with a soldering iron Both temperature and duration in mounting should meet the requirements of out-going SPEC; no stress should I allowed to occur in mounting; Don't let the tip of the soldering iron touch the X-CON itself. Mounting 2) Flow soldering X-CON capacitor body should be prohibited to submer in melted solder; both temperature and duration in mounting should meet the requirements of out-going SPEC; The rosin is not allowed to adhere to any where other than lead terminal. 1) Precautions on mounting status Do not tilt, bend twists X-CON; Do not allow other mat touch X-CON. 2) Washing the PCB (available cleaning agent 1) high quality alcohol-based cleaning fluid such as st-100s, 750L,750M;2) Detergents including substitute freon such as AK-225AES and IPA) Used immersion or ultrasonic waves to clean for a total the maximum operating temperature).		-							
Before mounting floor Products without remarkable polar, capacitance and rate voltage shouldn't be available 5) Precautions on the pitch between lead terminal and PCB The products can be used only when said pitch is match terminal and body of X-CON capacitors enduring in mounting 6) Precautions on the stress that lead terminal and body of X-CON capacitors enduring in mounting The products can be used for production only when lead terminal and body of X-CON capacitors enduring in mounting 1) Soldering with a soldering iron Both temperature and duration in mounting; Don't let the tip of the soldering iron touch the X-CON itself. Mounting 2) Flow soldering X-CON capacitor body should be prohibited to submerating should meet the requirements of out-going SPEC; The rosin is not allowed to adhere to any where other than lead terminal. 1) Precautions on mounting status Do not filt, bend twists X-CON; Do not allow other mat touch X-CON. 2) Washing the PCB (available Used immersion or ultrasonic waves to clean for a total less than 5 minutes and the temperature be less than 60 The conductivity, PH, specific gravity and water cleaning X-CON products should be dried with hot air (less than 5 minutes and the temperature).		-			, , , , , , , , , , , , , , , , , , ,				
Before mounting and rated voltage voltage shouldn't be available 5) Precautions on the pitch between lead terminal and PCB The products can be used only when said pitch is match terminal and body of X-CON capacitors enduring in mounting 6) Precautions on the stress that lead terminal and body of X-CON capacitors enduring in mounting The products can be used for production only when lead terminal and body of X-CON capacitors enduring in mounting 1) Soldering with a soldering iron Both temperature and duration in mounting should meet the requirements of out-going SPEC; no stress should I allowed to occur in mounting; Don't let the tip of the soldering iron touch the X-CON itself. 2) Flow soldering X-CON capacitor body should be prohibited to submer in melted solder; both temperature and duration in mounting should meet the requirements of out-going SPEC; The rosin is not allowed to adhere to any where other than lead terminal. 1) Precautions on mounting status Do not tilt, bend twists X-CON; Do not allow other mat touch X-CON. 2) Washing the PCB (available cleaning agent 1)high quality alcohol-based cleaning fluid such as st-100s, 750L,750M;2) Detergents including substitute freon such as AK-225AES and IPA) Used immersion or ultrasonic waves to clean for a total less than 5 minutes and the temperature be less than 60 The conductivity, PH, specific gravity and water cleaning X-CON products should be dried with hot air (less that the maximum operating temperature).									
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AK-225AES and IPA)				0	I A A A A A A A A A A A A A A A A A A A				
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10. It refers to the latest document of "Environment-related Substances standard"(WI-HSPM-QA-072).

	Substances						
	Cadmium and cadmium compounds						
Heavy metals	Lead and lead compounds						
	Mercury and mercury compounds						
	Hexavalent chromium compounds						
	Polychlorinated biphenyls (PCB)						
Chloinated	Polychlorinated naphthalenes (PCN)						
organic	Polychlorinated terphenyls (PCT)						
compounds	Short-chain chlorinated paraffins(SCCP)						
	Other chlorinated organic compounds						
	Polybrominated biphenyls (PBB)						
Brominated organic	Polybrominated diphenylethers(PBDE) (including						
	decabromodiphenyl ether[DecaBDE])						
compounds	Other brominated organic compounds						
Tributyltin comp	pounds(TBT)						
Triphenyltin con	npounds(TPT)						
Asbestos							
Specific azo con	npounds						
Formaldehyde							
Polyvinyl chlorid	de (PVC) and PVC blevds						
Beryllium oxide							
Beryllium copp	er						
Specific phthalat	tes (DEHP,DBP,BBP,DINP,DIDP,DNOP,DNHP)						
Hydrofluorocarb	on (HFC), Perfluorocarbon (PFC)						
Perfluorooctane	sulfonates (PFOS)						
Specific Benzotr	iazole						

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